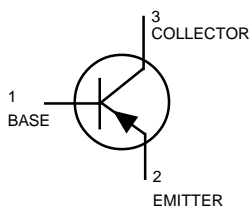


# Preliminary Information

## General Purpose Transistor

### PNP Silicon

These transistors are designed for general purpose amplifier applications. They are housed in the SOT-323/SC-70 package which is designed for low power surface mount applications.


**MMBT2907AWT1**


CASE 419-02, STYLE 3  
SOT-323 / SC-70

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	-60	Vdc
Collector-Base Voltage	$V_{CBO}$	-60	Vdc
Emitter-Base Voltage	$V_{EBO}$	-5.0	Vdc
Collector Current — Continuous	$I_C$	-600	mAdc

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A = 25^\circ\text{C}$	$P_D$	150	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	833	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

#### DEVICE MARKING

MMBT2907AWT1 = 2F

#### ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
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#### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage(2) ( $I_C = -10\text{ mAdc}, I_B = 0$ )	$V_{(BR)CEO}$	-60	—	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = -10\text{ mAdc}, I_E = 0$ )	$V_{(BR)CBO}$	-60	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = -10\mu\text{Adc}, I_C = 0$ )	$V_{(BR)EBO}$	-5.0	—	Vdc
Base Cutoff Current ( $V_{CE} = -30\text{Vdc}, V_{EB(OFF)} = -0.5\text{Vdc}$ )	$I_{BL}$	—	-50	nAdc
Collector Cutoff Current ( $V_{CE} = -30\text{Vdc}, V_{EB(OFF)} = -0.5\text{Vdc}$ )	$I_{CEX}$	—	-50	nAdc

1. FR-5 = 1.0 x 0.75 x 0.062 in.

2. Pulse Test: Pulse Width  $\leq 300\ \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

**MMBT2907AWT1**
**ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
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**ON CHARACTERISTICS**

DC Current Gain(1) (I <sub>C</sub> = -0.1 mA <sub>dc</sub> , V <sub>CE</sub> = -10 V <sub>dc</sub> ) (I <sub>C</sub> = -1.0 mA <sub>dc</sub> , V <sub>CE</sub> = -10 V <sub>dc</sub> ) (I <sub>C</sub> = -10 mA <sub>dc</sub> , V <sub>CE</sub> = -10 V <sub>dc</sub> ) (I <sub>C</sub> = -150 mA <sub>dc</sub> , V <sub>CE</sub> = -10 V <sub>dc</sub> ) (I <sub>C</sub> = -500 mA <sub>dc</sub> , V <sub>CE</sub> = -10 V <sub>dc</sub> )	$h_{FE}$	75 100 100 100 50	— — — — —	—
Collector-Emitter Saturation Voltage(1) (I <sub>C</sub> = -150 mA <sub>dc</sub> , I <sub>B</sub> = -15 mA <sub>dc</sub> ) (I <sub>C</sub> = -500 mA <sub>dc</sub> , I <sub>B</sub> = -50 mA <sub>dc</sub> )	$V_{CE(sat)}$	— —	-0.4 -1.6	V <sub>dc</sub>
Base-Emitter Saturation Voltage(1) (I <sub>C</sub> = -150 mA <sub>dc</sub> , I <sub>B</sub> = -15 mA <sub>dc</sub> ) (I <sub>C</sub> = -500 mA <sub>dc</sub> , I <sub>B</sub> = -50 mA <sub>dc</sub> )	$V_{BE(sat)}$	— —	-1.3 -2.6	V <sub>dc</sub>

**SMALL-SIGNAL CHARACTERISTICS**

Current-Gain — Bandwidth Product(4) (I <sub>C</sub> = -50 mA <sub>dc</sub> , V <sub>CE</sub> = 20 V <sub>dc</sub> , f = 100 MHz)	$f_T$	200	—	MHz
Output Capacitance (V <sub>CB</sub> = -10 V <sub>dc</sub> , I <sub>E</sub> = 0, f = 1.0 MHz)	$C_{obo}$	—	8.0	pF
Input Capacitance (V <sub>EB</sub> = -2.0 V <sub>dc</sub> , I <sub>C</sub> = 0, f = 1.0 MHz)	$C_{ibo}$	—	30	pF

**SWITCHING CHARACTERISTICS**

Turn-On Time (V <sub>CC</sub> = -30 V <sub>dc</sub> , I <sub>C</sub> = -150 mA <sub>dc</sub> , I <sub>B1</sub> = -15 mA <sub>dc</sub> )	$t_{on}$	—	45	ns
Delay Time	$t^d$	—	10	ns
Rise Time	$t_r$	—	40	ns
Storage Time (V <sub>CC</sub> = -6.0 V <sub>dc</sub> , I <sub>C</sub> = -150 mA <sub>dc</sub> , I <sub>B1</sub> = I <sub>B2</sub> = 15 mA <sub>dc</sub> )	$t_s$	—	80	ns
Fall Time	$t_f$	—	30	ns
Turn-Off Time	$t_{off}$	—	100	ns

1. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.